



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address: COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450
www.uspto.gov



Bib Data Sheet

CONFIRMATION NO. 5239

SERIAL NUMBER 10/762,514	FILING DATE 01/23/2004 RULE	CLASS 252	GROUP ART UNIT 1765	ATTORNEY DOCKET NO. 04329.2959-01
-----------------------------	---------------------------------------	--------------	------------------------	---

APPLICANTS

Gaku Minamihaba, Kawasaki-shi, JAPAN;

Hiroyuki Yano, Yokohama-shi, JAPAN;

** CONTINUING DATA *****

This application is a DIV of 10/303,855 11/26/2002 PAT 6,720,250

EC

** FOREIGN APPLICATIONS *****

JAPAN 2001-366938 11/30/2001

EC

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 04/26/2004

Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and Acknowledged	<input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Examiner's Signature <i>Eric Chun</i> Initials <i>EC</i>	STATE OR COUNTRY JAPAN	SHEETS DRAWING 3	TOTAL CLAIMS 11	INDEPENDENT CLAIMS 1
--	---	------------------------------	------------------------	-----------------------	----------------------------

ADDRESS

22852
FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER
LLP
901 NEW YORK AVENUE, NW
WASHINGTON, DC
20001-4413

TITLE

Slurry for chemical mechanical polishing for copper and method of manufacturing semiconductor device using the slurry

FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time)
------------	---	--